

3-Pin Microcontroller Reset Monitors

Features

- Precision V_{DD} Monitor for 2.5V, 3.0V, 3.3V, 5.0V Nominal System Voltage Supplies
- 140 msec Minimum RESET Time-Out Period
- RESET Output to $V_{DD} = 1.0V$ (**TCM809**)
- Low Supply Current, 9 μA (typ.)
- V_{DD} Transient Immunity
- Small 3-Pin SC-70 and SOT-23B Packages
- No External Components
- Push-Pull RESET Output
- Temperature Ranges:
 - Industrial: SC-70 (E): -40°C to +85°C
 - Extended: SOT-23, SC-70 (V): -40°C to +125°C

Applications

- Computers
- Embedded Systems
- Battery-powered Equipment
- Critical Microcontroller Power Supply Monitoring
- Automotive

Typical Application Circuit



General Description

The TCM809 and TCM810 are cost-effective system supervisor circuits designed to monitor V_{DD} in digital systems; providing a reset signal to the host processor, when necessary. No external components are required.

The RESET output is typically driven active within 65 μsec of V_{DD} falling through the reset voltage threshold. RESET is maintained active for a minimum of 140 msec after V_{DD} rises above the reset threshold. The TCM810 has an active-high RESET output, while the TCM809 has an active-low RESET output. The output of the TCM809/TCM810 is valid down to $V_{DD} = 1V$. Both devices are available in 3-Pin SC-70 and SOT-23B packages.

The TCM809/TCM810 are optimized to reject fast transient glitches on the V_{DD} line. A low supply current of 9 μA (typ., $V_{DD} = 3.3V$) make these devices suitable for battery-powered applications.

Pin Configurations



TCM809/TCM810

1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings†

| | |
|--|------------------------------|
| Supply Voltage (V_{DD} to GND) | 6.0V |
| RESET, RESET | -0.3V to ($V_{DD} + 0.3V$) |
| Input Current, V_{DD} | 20 mA |
| Output Current, RESET, RESET | 20 mA |
| dV/dt (V_{DD}) | 100V/ μ sec |
| Operating Temperature Range | -40°C to +125°C |
| Power Dissipation ($T_A = 70^\circ\text{C}$): | |
| 3-Pin SOT-23B (derate 4 mW/ $^\circ\text{C}$ above +70°C) | 320 mW |
| 3-Pin SC-70 (derate 2.17 mW/ $^\circ\text{C}$ above +70°C) | 174 mW |
| Storage Temperature Range | -65°C to +150°C |
| Maximum Junction Temperature, T_J | 150°C |

† **Notice:** Stresses above those listed under “Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

| V_{DD} = Full Range, T_A = Operating Temperature Range, unless otherwise noted. Typical values are at $T_A = +25^\circ\text{C}$, $V_{DD} = 5V$ for L/M/J, 3.3V for T/S, 3.0V for R and 2.5V for Z (Note 1). | | | | | | |
|---|----------|----------------|------|------|-----------------------|--|
| Parameter | Sym | Min | Typ | Max | Units | Test Conditions |
| V_{DD} Range | | 1.0 | — | 5.5 | V | $T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$ |
| | | 1.2 | — | 5.5 | | $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$ |
| Supply Current | I_{CC} | — | 12 | 30 | μA | TCM8xxL/M/J: $V_{DD} < 5.5V$ |
| | | — | 9 | 25 | | TCM8xxR/S/T/Z: $V_{DD} < 3.6V$ |
| Reset Threshold (Note 2) | V_{TH} | 4.56 | 4.63 | 4.70 | V | TCM8xxL: $T_A = +25^\circ\text{C}$ |
| | | 4.50 | — | 4.75 | | $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$ |
| | | 4.31 | 4.38 | 4.45 | V | TCM8xxM: $T_A = +25^\circ\text{C}$ |
| | | 4.25 | — | 4.50 | V | $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$ |
| | | 3.93 | 4.00 | 4.06 | V | TCM809J: $T_A = +25^\circ\text{C}$ |
| | | 3.89 | — | 4.10 | V | $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$ |
| | | 3.04 | 3.08 | 3.11 | V | TCM8xxT: $T_A = +25^\circ\text{C}$ |
| | | 3.00 | — | 3.15 | V | $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$ |
| | | 2.89 | 2.93 | 2.96 | V | TCM8xxS: $T_A = +25^\circ\text{C}$ |
| | | 2.85 | — | 3.00 | V | $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$ |
| | | 2.59 | 2.63 | 2.66 | V | TCM8xxR: $T_A = +25^\circ\text{C}$ |
| | | 2.55 | — | 2.70 | V | $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$ |
| | | 2.28 | 2.32 | 2.35 | V | TCM8xxZ: $T_A = +25^\circ\text{C}$ |
| | | 2.25 | — | 2.38 | V | $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$ |
| Reset Threshold Tempco | | — | 30 | — | ppm/ $^\circ\text{C}$ | |
| V_{DD} to Reset Delay, | | — | 65 | — | μsec | $V_{DD} = V_{TH}$ to ($V_{TH} - 100\text{ mV}$) (Note 2) |
| Reset Active Time Out Period | | 140 | 320 | 560 | msec | |
| RESET Output Voltage Low (TCM809) | V_{OL} | — | — | 0.3 | V | TCM809R/S/T/Z: $V_{DD} = V_{TH}$ min, $I_{SINK} = 1.2\text{ mA}$ TCM809L/M/J: $V_{DD} = V_{TH}$ min, $I_{SINK} = 3.2\text{ mA}$ $V_{DD} > 1.0V$, $I_{SINK} = 50\ \mu\text{A}$ |
| RESET Output Voltage High (TCM809) | V_{OH} | 0.8 V_{DD} | — | — | V | TCM809R/S/T/Z: $V_{DD} > V_{TH}$ max, $I_{SOURCE} = 500\ \mu\text{A}$ |
| | | $V_{DD} - 1.5$ | — | — | | TCM809L/M/J: $V_{DD} > V_{TH}$ max, $I_{SOURCE} = 800\ \mu\text{A}$ |
| RESET Output Voltage Low (TCM810) | V_{OL} | — | — | 0.3 | V | TCM810R/S/T/Z: $V_{DD} = V_{TH}$ max, $I_{SINK} = 1.2\text{ mA}$ |
| | | — | — | 0.4 | | TCM810L/M: $V_{DD} = V_{TH}$ max, $I_{SINK} = 3.2\text{ mA}$ |
| RESET Output Voltage High (TCM810) | V_{OH} | 0.8 V_{DD} | — | — | V | $1.8 < V_{DD} < V_{TH}$ min, $I_{SOURCE} = 150\ \mu\text{A}$ |

- Note 1:** Production testing done at $T_A = +25^\circ\text{C}$, overtemperature limits ensured by QC screen.
Note 2: RESET output for **TCM809**, RESET output for **TCM810**.

2.0 TYPICAL PERFORMANCE CHARACTERISTICS

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.



FIGURE 2-1: Supply Current vs. Temperature.



FIGURE 2-3: Power-up Reset Time Out vs. Temperature.



FIGURE 2-2: Supply Current vs. Temperature.



FIGURE 2-4: Normalized Reset Threshold vs. Temperature.

TCM809/TCM810

3.0 PIN DESCRIPTIONS

The descriptions of the pins are given in Table 3-1.

TABLE 3-1: PIN FUNCTION TABLE

| NAME | FUNCTION |
|-----------------|--|
| GND | Ground |
| RESET (TCM809) | RESET push-pull output |
| RESET (TCM810) | RESET push-pull output |
| V _{DD} | Supply voltage (+2.5V, +3.0V, +3.3V, +5.0V). |

3.1 Ground (GND)

Ground terminal.

3.2 RESET Output (TCM809)

The RESET push-pull output remains low while V_{DD} is below the reset voltage threshold, and for 240 msec (140 msec min.) after V_{DD} rises above reset threshold.

3.3 RESET Output (TCM810)

The RESET push-pull output remains high while V_{DD} is below the reset voltage threshold, and for 240 msec (140 msec min.) after V_{DD} rises above reset threshold.

3.4 Supply Voltage (V_{DD})

V_{DD}: +2.5V, +3.0V, +3.3V and +5.0V

4.0 APPLICATIONS INFORMATION

4.1 V_{DD} Transient Rejection

The TCM809/TCM810 provides accurate V_{DD} monitoring and reset timing during power-up, power-down and brown-out/sag conditions. These devices also reject negative-going transients (glitches) on the power supply line. Figure 4-1 shows the maximum transient duration vs. maximum negative excursion (overdrive) for glitch rejection. Any combination of duration and overdrive that lies under the curve will not generate a reset signal.



FIGURE 4-1: Maximum Transient Duration vs. Overdrive for Glitch Rejection at $+25^\circ\text{C}$.

Combinations above the curve are detected as a brown-out or power-down condition. Transient immunity can be improved by adding a capacitor in close proximity to the V_{DD} pin of the TCM809/TCM810.

4.2 $\overline{\text{RESET}}$ Signal Integrity During Power-Down

The TCM809 $\overline{\text{RESET}}$ output is valid to $V_{DD} = 1.0\text{V}$. Below this voltage the output becomes an "open circuit" and does not sink current. This means CMOS logic inputs to the microcontroller will be floating at an undetermined voltage. Most digital systems are completely shut down well above this voltage. However, in situations where $\overline{\text{RESET}}$ must be maintained valid to $V_{DD} = 0\text{V}$, a pull-down resistor must be connected from $\overline{\text{RESET}}$ to ground to discharge stray capacitances and hold the output low (Figure 4-2). This resistor value, though not critical, should be chosen such that it does not appreciably load $\overline{\text{RESET}}$ under normal operation (100 k Ω will be suitable for most applications). Similarly, a pull-up resistor to V_{DD} is required for the TCM810 to ensure a valid high $\overline{\text{RESET}}$ for V_{DD} below 1.0V.



FIGURE 4-2: The addition of R_1 at the $\overline{\text{RESET}}$ output of the TCM809 ensures that the $\overline{\text{RESET}}$ output is valid to $V_{DD} = 0\text{V}$.

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4.3 Controllers and Processors With Bidirectional I/O Pins

Some microcontrollers have bidirectional reset pins. Depending on the current drive capability of the controller pin, an indeterminate logic level may result if there is a logic conflict. This can be avoided by adding a 4.7 k Ω resistor in series with the output of the TCM809/TCM810 (Figure 4-3). If there are other components in the system that require a reset signal, they should be buffered so as not to load the reset line. If the other components are required to follow the reset I/O of the microcontroller, the buffer should be connected as shown with the solid line.



FIGURE 4-3: Interfacing the TCM809 to a Bidirectional RESET I/O.

5.0 PACKAGING INFORMATION

5.1 Package Marking Information

3-Pin SOT-23B



Example:

| Customer Specific Information Codes for: | | | |
|--|-----|----------|--------|
| Part Number | | TCM8xx = | |
| | | TCM809 | TCM810 |
| TCM8xxL | ENB | J1 | K1 |
| | VNB | JZ | KZ |
| TCM8xxM | ENB | J2 | K2 |
| | VNB | JY | KY |
| TCM8xxT | ENB | J3 | K3 |
| | VNB | JX | KX |
| TCM8xxS | ENB | J4 | K4 |
| | VNB | JV | KV |
| TCM8xxR | ENB | J5 | K5 |
| | VNB | JU | KU |
| TCM8xxJ | ENB | J6 | — |
| | VNB | JT | KS |
| TCM8xxZ | ENB | J7 | K6 |

3-Pin SC-70



Example:

| Customer Specific Information Codes for: | | | |
|--|-----|----------|--------|
| Part Number | | TCM8xx = | |
| | | TCM809 | TCM810 |
| TCM8xxL | ELB | J1 | — |
| | VLB | JZ | KZ |
| TCM8xxM | ELB | J2 | — |
| | VLB | JY | KY |
| TCM8xxT | ELB | J3 | — |
| | VLB | JX | KX |
| TCM8xxS | ELB | J4 | — |
| | VLB | JV | KV |
| TCM8xxR | ELB | J5 | — |
| | VLB | JU | KU |
| TCM8xxJ | ELB | J6 | — |
| | VLB | JT | KS |
| TCM8xxZ | ELB | J7 | — |
| | VLB | JS | KT |

OR



Legend: XX...X Customer-specific information*
 Y Year code (last digit of calendar year)
 YY Year code (last 2 digits of calendar year)
 WW Week code (week of January 1 is week '01')
 NNN Alphanumeric traceability code
 (e3) Pb-free JEDEC designator for Matte Tin (Sn)
 * This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

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3-Lead Plastic Small Outline Transistor (NB) (SOT-23)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Dimension Limits | Units | INCHES* | | | MILLIMETERS | | |
|----------------------------|-------|---------|------|------|-------------|------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX |
| Number of Pins | n | | 3 | | | 3 | |
| Pitch | p | | .038 | | | 0.96 | |
| Outside lead pitch (basic) | p1 | | .076 | | | 1.92 | |
| Overall Height | A | .035 | .040 | .044 | 0.89 | 1.01 | 1.12 |
| Molded Package Thickness | A2 | .035 | .037 | .040 | 0.88 | 0.95 | 1.02 |
| Standoff § | A1 | .000 | .002 | .004 | 0.01 | 0.06 | 0.10 |
| Overall Width | E | .083 | .093 | .104 | 2.10 | 2.37 | 2.64 |
| Molded Package Width | E1 | .047 | .051 | .055 | 1.20 | 1.30 | 1.40 |
| Overall Length | D | .110 | .115 | .120 | 2.80 | 2.92 | 3.04 |
| Foot Length | L | .014 | .018 | .022 | 0.35 | 0.45 | 0.55 |
| Foot Angle | φ | 0 | 5 | 10 | 0 | 5 | 10 |
| Lead Thickness | c | .004 | .006 | .007 | 0.09 | 0.14 | 0.18 |
| Lead Width | B | .015 | .017 | .020 | 0.37 | 0.44 | 0.51 |
| Mold Draft Angle Top | α | 0 | 5 | 10 | 0 | 5 | 10 |
| Mold Draft Angle Bottom | β | 0 | 5 | 10 | 0 | 5 | 10 |

* Controlling Parameter

§ Significant Characteristic

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: TO-236

Drawing No. C04-104

3-Lead Plastic Small Outline Transistor (LB) (SC-70)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Dimension Limits | Units | INCHES | | MILLIMETERS* | |
|----------------------------|-------|-----------|-------|--------------|------|
| | | MIN | MAX | MIN | MAX |
| Number of Pins | | 3 | | 3 | |
| Pitch | P | .026 BSC. | | 0.65 BSC. | |
| Outside lead pitch (basic) | p1 | .051 BSC. | | 1.30 BSC. | |
| Overall Height | A | .031 | .043 | 0.80 | 1.10 |
| Molded Package Thickness | A2 | .031 | .039 | 0.80 | 1.00 |
| Standoff | A1 | .000 | .0004 | 0.00 | .010 |
| Overall Width | E | .071 | .094 | 1.80 | 2.40 |
| Molded Package Width | E1 | .045 | .053 | 1.15 | 1.35 |
| Overall Length | D | .071 | .089 | 1.80 | 2.25 |
| Foot Length | L | .004 | .016 | 0.10 | 0.41 |
| Lead Thickness | c | .003 | .010 | 0.08 | 0.25 |
| Lead Width | B | .006 | .016 | 0.15 | 0.40 |
| Mold Draft Angle Top | a | 8° | 12° | 8° | 12° |
| Mold Draft Angle Bottom | b | 8° | 12° | 8° | 12° |

*Controlling Parameter

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .005" (0.127mm) per side.

JEITA (EIAJ) Equivalent: SC70

Drawing No. C04-104

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5.2 Product Tape and Reel Specifications

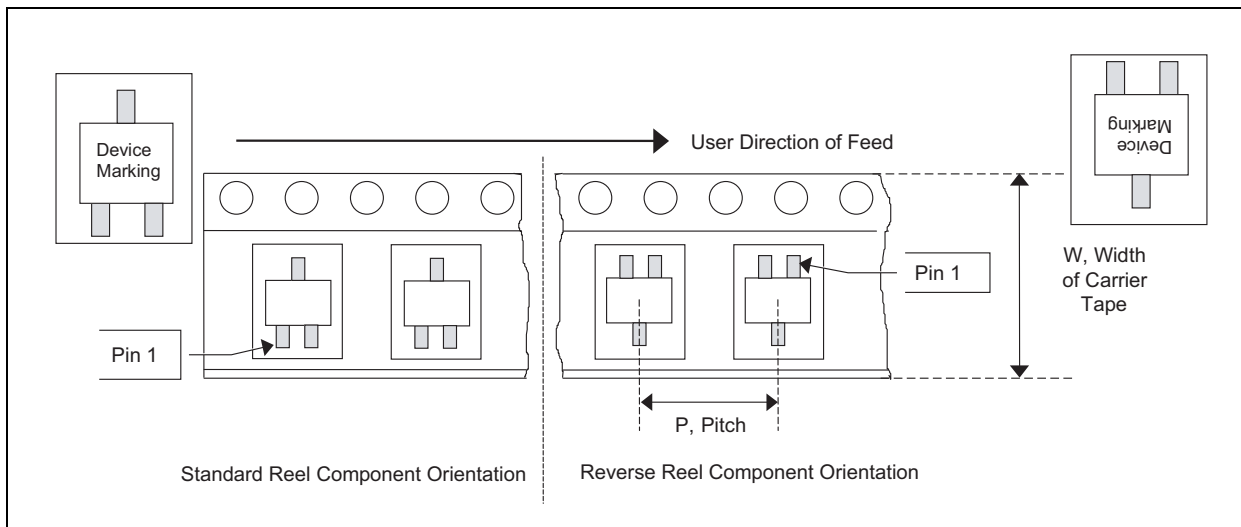
FIGURE 5-1: EMBOSSED CARRIER DIMENSIONS (8, 12, 16 AND 24 MM TAPE ONLY)



TABLE 1: CARRIER TAPE/CAVITY DIMENSIONS

| Case Outline | Package Type | | Carrier Dimensions | | Cavity Dimensions | | | Output Quantity Units | Reel Diameter in mm |
|--------------|--------------|----|--------------------|------|-------------------|-------|-------|-----------------------|---------------------|
| | | | W mm | P mm | A0 mm | B0 mm | K0 mm | | |
| NB | SOT-23 | 3L | 8 | 4 | 3.15 | 2.77 | 1.22 | 3000 | 180 |
| LB | SC-70 | 3L | 8 | 4 | 2.4 | 2.4 | 1.19 | 3000 | 180 |

FIGURE 5-2: 3-LEAD SOT-23/SC70 DEVICE TAPE AND REEL SPECIFICATIONS



APPENDIX A: REVISION HISTORY

Revision E (December 2012)

- Added a note to each package outline drawing.

Revision D (March 2005)

- Updated 6.0 “**Packaging Information**” to include old and new packaging examples.
- Applied new template and rearranged sections to be consistent with current documentation.

Revision C (April 2004)

Revision B (January 2002)

Revision A (May 2001)

Initial release of data sheet.

TCM809/TCM810

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

| <u>PART NO.</u> | <u>X</u> | <u>X</u> | <u>XXXXX</u> | Examples: |
|--|---------------------------------------|----------------------|--------------|--|
| Device | V _{DD} Reset Threshold | Temperature Range | Package | |
| Device: TCM809: Supervisor circuit with active-low $\overline{\text{RESET}}$ output TCM810: Supervisor circuit with active-high RESET output V _{DD} Reset Threshold: L = 4.63V M = 4.38V J = 4.00V T = 3.08V S = 2.93V R = 2.63V Z = 2.32V Temperature Range: E = -40°C to +85°C V = -40°C to +125°C Package: NB713 = SOT-23B, 3-pin (Tape and Reel) LB713 = SC-70, 3-pin (Tape and Reel) | | | | a) TCM809LENB713: SOT-23B-3-TR, Microcontroller 4.63V Reset Monitor, -40°C to +85°C, Tape and Reel. b) TCM809LVLB713: SC-70-3-TR, Microcontroller 4.63V Reset Monitor, -40°C to +125°C, Tape and Reel. c) TCM809LVNB713: SOT-23B-3-TR, Microcontroller 4.63V Reset Monitor, -40°C to +125°C, Tape and Reel. a) TCM810MENB713: SOT-23B-3-TR, Microcontroller 4.38V Reset Monitor, -40°C to +85°C, Tape and Reel. b) TCM810RVLB713: SOT-23B-3-TR, Microcontroller 2.63V Reset Monitor, -40°C to +125°C, Tape and Reel. c) TCM810TVLB713: SC-70-3-TR, Microcontroller 4.38V Reset Monitor, -40°C to +125°C, Tape and Reel. |

Sales and Support

Data Sheets

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2. The Microchip Worldwide Site (www.microchip.com)

Please specify which device, revision of silicon and Data Sheet (include Literature #) you are using.

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NOTES:

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Fax: 86-571-2819-3189

China - Hong Kong SAR
Tel: 852-2943-5100
Fax: 852-2401-3431

China - Nanjing
Tel: 86-25-8473-2460
Fax: 86-25-8473-2470

China - Qingdao
Tel: 86-532-8502-7355
Fax: 86-532-8502-7205

China - Shanghai
Tel: 86-21-5407-5533
Fax: 86-21-5407-5066

China - Shenyang
Tel: 86-24-2334-2829
Fax: 86-24-2334-2393

China - Shenzhen
Tel: 86-755-8864-2200
Fax: 86-755-8203-1760

China - Wuhan
Tel: 86-27-5980-5300
Fax: 86-27-5980-5118

China - Xian
Tel: 86-29-8833-7252
Fax: 86-29-8833-7256

China - Xiamen
Tel: 86-592-2388138
Fax: 86-592-2388130

China - Zhuhai
Tel: 86-756-3210040
Fax: 86-756-3210049

ASIA/PACIFIC

India - Bangalore
Tel: 91-80-3090-4444
Fax: 91-80-3090-4123

India - New Delhi
Tel: 91-11-4160-8631
Fax: 91-11-4160-8632

India - Pune
Tel: 91-20-2566-1512
Fax: 91-20-2566-1513

Japan - Osaka
Tel: 81-6-6152-7160
Fax: 81-6-6152-9310

Japan - Tokyo
Tel: 81-3-6880-3770
Fax: 81-3-6880-3771

Korea - Daegu
Tel: 82-53-744-4301
Fax: 82-53-744-4302

Korea - Seoul
Tel: 82-2-554-7200
Fax: 82-2-558-5932 or
82-2-558-5934

Malaysia - Kuala Lumpur
Tel: 60-3-6201-9857
Fax: 60-3-6201-9859

Malaysia - Penang
Tel: 60-4-227-8870
Fax: 60-4-227-4068

Philippines - Manila
Tel: 63-2-634-9065
Fax: 63-2-634-9069

Singapore
Tel: 65-6334-8870
Fax: 65-6334-8850

Taiwan - Hsin Chu
Tel: 886-3-5778-366
Fax: 886-3-5770-955

Taiwan - Kaohsiung
Tel: 886-7-213-7828
Fax: 886-7-330-9305

Taiwan - Taipei
Tel: 886-2-2508-8600
Fax: 886-2-2508-0102

Thailand - Bangkok
Tel: 66-2-694-1351
Fax: 66-2-694-1350

EUROPE

Austria - Wels
Tel: 43-7242-2244-39
Fax: 43-7242-2244-393

Denmark - Copenhagen
Tel: 45-4450-2828
Fax: 45-4485-2829

France - Paris
Tel: 33-1-69-53-63-20
Fax: 33-1-69-30-90-79

Germany - Munich
Tel: 49-89-627-144-0
Fax: 49-89-627-144-44

Italy - Milan
Tel: 39-0331-742611
Fax: 39-0331-466781

Netherlands - Drunen
Tel: 31-416-690399
Fax: 31-416-690340

Spain - Madrid
Tel: 34-91-708-08-90
Fax: 34-91-708-08-91

UK - Wokingham
Tel: 44-118-921-5869
Fax: 44-118-921-5820

11/29/12



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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Факс: 8 (812) 320-02-42

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